

ELECTRICAL CHARACTERISTICS

The electrical characteristics of a SMT50 device are similar to that of a self-gated Triac, but the SMT50 is a two terminal device with no gate. The gate function is achieved by an internal current controlled mechanism.

Like the T.V.S. diodes, the SMT50 has a standoff voltage (Vrm) which should be equal to or greater than the operating voltage of the system to be protected. At this voltage (Vrm) the current consumption of the SMT50 is negligible and will not affect the protected system.

When a transient occurs, the voltage across the SMT50 will increase until the breakdown voltage (Vbr) is reached. At this point the device will operate in a similar way to a T.V.S. device and is in avalanche mode.

The voltage of the transient will now be limited and will only increase by a few volts as the device diverts more current. As this transient current rises, a level of current through the device is reached (Ibo) which causes the device to switch to a fully conductive state such that the voltage across the device is now only a few volts (Vt). The voltage at which the device switched from the avalanche mode to the fully conductive state (Vt) is known as the Breakover voltage (Vbo). When the device is in the Vt state, high currents can be diverted without damage to the SMT50 due to the low voltage across the device, since the limiting factor in such devices is dissipated power (V x I).

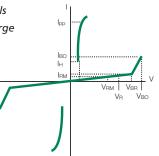
Resetting of the device to the non-conducting state is controlled by the current flowing through the device. When the current falls below a certain value, known as the Holding Current (Ih), the device resets automatically.

As with the avalanche T.V.S. device, if the SMT50 is subjected to a surge current which is beyond its maximum rating, then the device will fail in short circuit mode, ensuring that the equipment is ultimately protected.

SELECTING A SMT50

1. When selecting a SMT50 device, it is important that the Vrm of the device is equal to or greater than the the operating voltage of the system.

2. The minimum Holding Current (Ih) must be greater than the current the system is capable of delivering otherwise the device will remain conducting following a transient condition. V-I Graph illustrating symbols and terms for the SMT50 surge protection device.



COMPLIES WITH THE FOLLOWING STANDARDS	PEAK SURGE VOLTAGE	VOLTAGE WAVEFORM	CURRENT WAVEFORM	ADMISSIBLE IPP	NECESSARY RESISTOR
	(V)	(μS)	(μS)	(A)	(Ω)
(CCITT) ITU-K20	1000	10/700	5/310	25	-
(CCITT) ITU-K17	1500	10/700	5/310	38	-
VDE0433	2000	10/700	5/310	50	-
VDE0878	2000	1.2/50	1/20	50	-
IEC-1000-4-5	level 3	10/700	5/310	50	-
	level 4	1.2/500	8/20	100	-
FCC Part 68, lightning surge	1500	10/160	10/160	75	12.5
type A	800	10/560	10/560	55	6.5
FCC Part 68, lightning surge	1000	9/720	5/320	25	-
type B					
Bellcore TR-NWT-001089	2500	2/10	2/10	150	11.5
first level	1000	10/1000	10/1000	50	10
Bellcore TR-NWT-001089	5000	2/10	2/10	150	11.5
second level					
CNET I31-24	1000	0.5/700	0.8/310	25	-

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ELECTRICAL CHARACTERISTICS (Tamb 25°C)

SYMBOL	PARAMETER	SYMBOL	PARAMETER
V _{RM}	Stand-off Voltage	V _{bo}	Breakover Voltage
I _{RM}	Leakage Current at Stand-off Voltage	I _H	Holding Current
V _R	Continuous Reverse Voltage	I _{BO}	Breakover Current
V _{BR}	Breakdown Voltage	l _{pp}	Peak pulse Current
С	Capacitance		

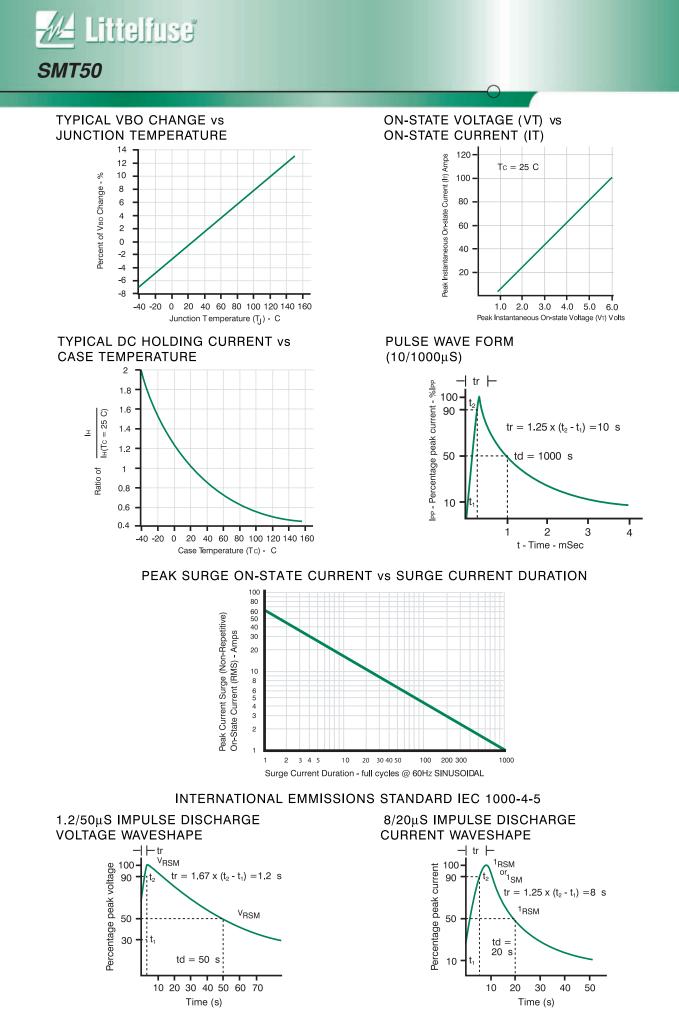
THERMAL RESISTANCE					
SYMBOL	PARAMETER	VALUE	UNIT		
R _{TH} (J-I)	Junction to leads	20	°C/W		
R _{TH} (J-I)	Junction to ambient on printed circuit (with standard footprint dimensions)	100	°C/W		

ABSOLUTE MAXIMUM RATINGS (Tamb 25°C)						
SYMBOL	PARAMETER		VALUE	UNIT		
Р	Power dissipation	Tlead	5	W		
I _{PP}	Peak pulse current	10/1000µS	50	А		
		8/20µS	100	А		
I _{TSM}	Non repetitive surge peak on-state current	tp + 20ms	30	А		
dV/dt	Critical rate of rise of off-state voltage	Vrm	5	KV/µS		
Tstg	Storage temperature range		-55 to +150	°C		
Tj	Maximum junction temperature		150	°C		
TL	Maximum lead temperature for soldering during 10s		260	Tstg		

Туре	Marking	IRM @ VRM MAX		IRM @ VR MAX		Vво @ Іво МАХ		ін MIN	C MAX
	Laser	(µA)	(V)	(µA)	(V)	(V)	(mA)	(Note 1) (mA)	(pF)
SMT50-62	A062	2	56	50	62	82	800	150	150
SMT50-68	A068	2	60	50	68	90	800	150	150
SMT50-100	A100	2	90	50	100	133	800	150	100
SMT50-120	A120	2	180	50	120	160	800	150	100
SMT50-130	A130	2	117	50	130	173	800	150	100
SMT50-180	A180	2	162	50	180	240	800	150	100
SMT50-200	A200	2	180	50	200	267	800	150	100
SMT50-220	A220	2	198	50	220	293	800	150	100
SMT50-240	A240	2	216	50	240	320	800	150	100
SMT50-270	A270	2	243	50	270	360	800	150	100

All parameters are tested @ 25°C except where indicated.

Note 1: Measured @ 1V bias, 1MHz All parameters are tested using a FET TEST[™] model 3600



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